

06-16-1998

COVER SHEET

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To the Assistant Commissioner for I

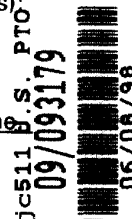
document(s) or copy(ies) thereof.

1. Name of conveying party(ies):

Toshio IWASAKI  
Shin-ichi FUJIMOTO  
Hiroshi ISOMURA  
Takayoshi ISHIDA  
Michiharu TAMURA  
Atsushi IKARI

2. Name and address of receiving party(ies):

Name: Nippon Steel Corporation  
Street Address: 6-3, Otemachi 2-chome  
Chiyoda-ku, Tokyo Japan



Additional name(s) of conveying party(ies) attached? No

3. Nature of conveyance:

Assignment                      Merger  
 Security Agreement              Change of Name  
 Other  
Execution Date: May 28, 29 and 30, 1998

Additional name(s) & address(es) attached? Yes

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: May 28, 29 and 30, 1998

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.  
Internal Address: Michael R. Davis, Esq.  
Street Address: 2033 K Street, N.W., Suite 800

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. § 3.41). . . . . \$ 40.00

Enclosed [Check No. 38933]  
 Authorized to be charged to deposit account

8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael R. Davis, Reg. No. 25,134  
Name of Person Signing

*Michael R. Davis*  
Signature

June 8, 1998  
Date

Total number of pages including cover sheet, attachments, and document: 4

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks  
Box Assignments  
Washington, D.C. 20231

THIS COMMISSIONER IS AUTHORIZED TO ACCEPT FOR DEPOSIT AND TO ISSUE PATENT COPIES TO APPLICANTS AND TO THE PUBLIC.

CONTINUATION OF ITEM 2

Name: NSC Electron Corporation

Street Address: 11-12, Hatchobori 3-chome, Chuo-ku, Tokyo Japan

# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Toshio Iwasaki, Shin-ichi Fujimoto, Hiroshi Isomura,

Takayoshi Ishida, Michiharu Tamura and Atsushi Ikari

Insert Name(s)  
of Inventor(s)

the undersigned hereby sell(s) and assign(s) to

Nippon Steel Corporation and NSC Electron Corporation

Insert Name(s)  
of Assignee(s)

of 6-3, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan and 11-12,

Address

Hatchobori 3-chome, Chuo-ku, Tokyo, Japan  
(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

METHOD FOR PRODUCTION OF DISLOCATION-FREE SILICON SINGLE

Title of  
Invention

CRYSTAL

Date of Signing  
of Application

for which an application for patent in the United States has been executed by the undersigned on  
respectively May 28, 30, 28, 29, 30 and 30, 1998

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 28/5/1998, Name of Inventor Toshio Iwasaki  
 Date 20/5/1998, Name of Inventor Shin-ichi Fujimoto  
 Date 28/5/1998, Name of Inventor Hiroshi Isomura  
 Date 28/5/1998, Name of Inventor Takayoshi Ishida  
 Date 28/5/1998, Name of Inventor Michiharu Tamura  
 Date 2/5/1998, Name of Inventor Atsushi Ikari

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Hirofumi Harada  
 Witness Takeji Serzaki

**ACKNOWLEDGEMENT**

\_\_\_\_\_ } ss  
 \_\_\_\_\_ }

This \_\_\_\_\_ day of \_\_\_\_\_, 19\_\_\_\_, before me personally came the above-named \_\_\_\_\_

to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL \_\_\_\_\_  
 \_\_\_\_\_  
 Official Signature  
 \_\_\_\_\_  
 Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_  
 Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_  
 Title of Invention \_\_\_\_\_